

Product Change Notice

(Notification - P1407035)

July 31, 2014

To: *Our Valued Digi-Key Customer*

Overview: The purpose of this notification is to communicate a product change of select Renesas Electronics America, Inc. (REA) devices. These devices are changing wafer fabrication sites. There is no part number change.

Affected Products: The accompanying letter, provided by Digi-Key, lists the products which may affect your company.

Part numbers given in this list are for active part numbers in REA database at the time of this notification.

Key Dates:

Shipments from REA of products from the updated wafer fabrication site begin. Cross shipments between the original and updated site may continue for a period of time.

Apr. 15th, 2015

Response: No response is required. REA will consider this notification approved 30 days after its issue. If you anticipate volumes beyond your regular rate prior to the transition date, please contact your REA sales representative with a forecast of your requirements.

You are encouraged to sample material from the updated wafer fabrication site and begin qualification as soon as possible. Please contact you REA sales representative for sampling information.

Please contact your REA sales representative for any questions or comments.

Thank you for your attention.

Sincerely,

Renesas Electronics America, Inc.

Booking Part number	Customer Note
2SA1010-AZ	Wafer Fabrication Site Change from Shiga to Naka
2SA1412-AZ	Wafer Fabrication Site Change from Shiga to Naka
2SA1646(0)-Z-E1-AZ	Wafer Fabrication Site Change from Shiga to Naka
2SC2335-AZ	Wafer Fabrication Site Change from Shiga to Naka
2SC2335-S-AZ	Wafer Fabrication Site Change from Shiga to Naka
2SK3576(0)-T1B-AT	Wafer Fabrication Site Change from Shiga to Kawashiri
N0435N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0436N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0437N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0438N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0605N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0607N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0608N#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
N0609N-S19-AY#YW	Wafer Fabrication Site Change from Shiga to Kawashiri
NP33N075YDF-E1-AY	Wafer Fabrication Site Change from Shiga to Kawashiri
NP82N06PLG(1)-E1-AY	Wafer Fabrication Site Change from Shiga to Naka
UPA1764G(0)-E2-AT	Wafer Fabrication Site Change from Shiga to Kawashiri
UPA2820T1S-E2-AT	Wafer Fabrication Site Change from Shiga to Naka
UPA2825T1S-E2-AT	Wafer Fabrication Site Change from Shiga to Naka
UPA2830T1L-E2-AY#YW	Wafer Fabrication Site Change from Shiga to Naka
UPA3753GR-E1-AT	Wafer Fabrication Site Change from Shiga to Kawashiri
UPD166024T1K-E1-AY	Wafer Fabrication Site Change from Shiga to Kawashiri
UPD166031T1U-E1-AY	Wafer Fabrication Site Change from Shiga to Kawashiri
UPD166032T1U-E1-AY#YK0	Wafer Fabrication Site Change from Shiga to Kawashiri
R8A77401PB00BG#U0	Wafer Fabrication Site Change from Tsuruoka to Naka
UPD76F0171GC(A2)-UEU-CAR-AX	Wafer Fabrication Site Change from Tsuruoka to Naka
UPD70F3794GC(R)-012-UEU-AX	Wafer Fabrication Site Reduction from Kawashiri/Shiga to Kawashiri
UPD78F0376GK(S)-8EU-A	Wafer Fabrication Site Reduction from Yamaguchi/Kawashiri/Shiga to Yamaguchi/Kawashiri
UPD78F0385GK(R)-8EU-A	Wafer Fabrication Site Reduction from Kawashiri/Shiga to Kawashiri
UPD78F0421GB-GAG-E1-AX	Wafer Fabrication Site Reduction from Kawashiri/Shiga to Kawashiri
UPD78F0432GB-GAG-E2-AX	Wafer Fabrication Site Reduction from Kawashiri/Shiga to Kawashiri
UPD78F0444GB(S)-GAH-AX	Wafer Fabrication Site Reduction from Kawashiri/Shiga to Kawashiri
UPD78F0537DGK-UET-A	Wafer Fabrication Site Reduction from Kawashiri/Shiga to Kawashiri
UPD78F8055GC-UEU-AX	Wafer Fabrication Site Reduction from Yamaguchi/Kawashiri/Shiga to Yamaguchi/Kawashiri
UPD79F0078GA(S)-405-GAM-AX	Wafer Fabrication Site Reduction from Kawashiri/Shiga/TSA to Kawashiri/TSA